

DMTH10H032SPSW 100V +175°C N-CHANNEL ENHANCEMENT MODE MOSFET

PowerDI5060-8

Product Summary

BV _{DSS}	R _{DS(ON)} ID Tc = +25	
100V	32mΩ @ V _{GS} = 10V	25A

Description and Applications

This MOSFET is designed to minimize the on-state resistance $(R_{DS(ON)})$ yet maintain superior switching performance, making it ideal for high efficiency power management applications.

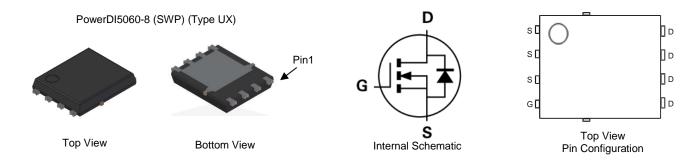
- Synchronous rectifiers
- Backlighting
- Power management functions
- DC-DC converters

Features

- 100% Unclamped Inductive Switching (UIS) Test in Production Ensures More Reliable and Robust End Application
- High Conversion Efficiency
- Low Input Capacitance
- Fast Switching Speed
- Wettable Flank for Improved Optical Inspection
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please <u>contact us</u> or your local Diodes representative. <u>https://www.diodes.com/quality/product-definitions/</u>

Mechanical Data

- Package: PowerDI[®]5060-8
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Finish Matte Tin Annealed over Copper Leadframe; Solderable per MIL-STD-202, Method 208 (@3)
- Weight: 0.097 grams (Approximate)



Ordering Information (Note 4)

Part Number	Package	Packing		
	Fackage	Qty.	Carrier	
DMTH10H032SPSW-13	PowerDI5060-8 (SWP) (Type UX)	2,500	Tape & Reel	

Notes:

 EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.



Marking Information



Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Drain-Source Voltage		VDSS	100	V
Gate-Source Voltage		V _{GSS}	±20	V
Continuous Drain Current, V _{GS} = 10V (Note 5)	Tc = +25°C Tc = +100°C	lр	25 17	A
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)		Ідм	100	А
Maximum Continuous Body Diode Forward Current (No	ls	25	А	
Pulsed Body Diode Forward Current (10µs Pulse, Duty	I _{SM}	100	А	
Avalanche Current, L = 0.3mH (Note 6)		las	13	A
Avalanche Energy, L = 0.3mH (Note 6)		Eas	25.3	mJ

Thermal Characteristics

Notes:

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 7)	T _A = +25°C	PD	3.2	W
Thermal Resistance, Junction to Ambient (Note 7)		R _{0JA}	47	°C/W
Total Power Dissipation (Note 5)	Tc = +25°C	PD	38	W
Thermal Resistance, Junction to Case (Note 5)		Rejc	3.9	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +175	°C

5. Thermal resistance from junction to soldering point (on the exposed drain pad).

6. I_{AS} and E_{AS} ratings are based on low frequency and duty cycles to keep $T_J = +25^{\circ}$ C. 7. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.



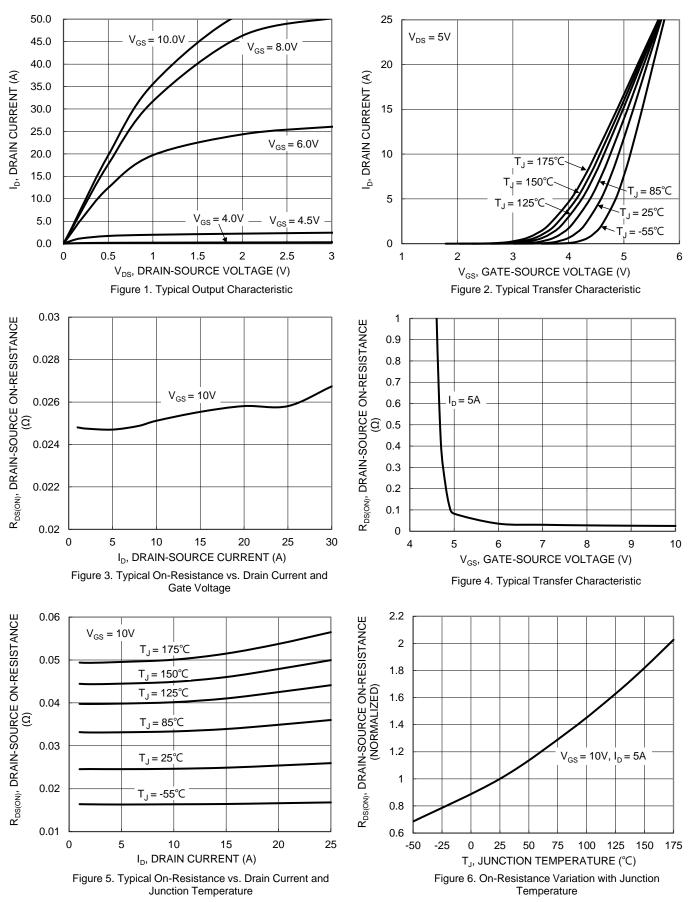
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)			, ,,		1	I	
Drain-Source Breakdown Voltage	BVDSS	100	—	_	V	$V_{GS} = 0V, I_D = 1mA$	
Zero Gate Voltage Drain Current	IDSS		_	1	μA	V _{DS} = 80V, V _{GS} = 0V	
Gate-Source Leakage	lgss		_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)	-						
Gate Threshold Voltage	Vgs(th)	2	—	4	V	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	
Static Drain-Source On-Resistance	R _{DS(ON)}	_	24	32	mΩ	$V_{GS} = 10V, I_D = 5A$	
Diode Forward Voltage	V _{SD}		0.8	1	V	$V_{GS} = 0V, I_S = 5A$	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	Ciss		544	_	pF	$V_{DS} = 50V, V_{GS} = 0V$ f = 1MHz	
Output Capacitance	Coss		181	_	pF		
Reverse Transfer Capacitance	Crss		6.0	_	pF		
Gate Resistance	Rg	_	1.2		Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$	
Total Gate Charge (V _{GS} = 4.5V)	Qg		4.3		nC		
Total Gate Charge (V _{GS} = 10V)	Qg		8.0	_	nC	V _{DS} = 50V, I _D = 7A	
Gate-Source Charge	Qgs	_	1.8		nC	VDS = 50V, ID = 7A	
Gate-Drain Charge	Q _{gd}	_	2.4		nC		
Turn-On Delay Time	t _{D(ON)}	_	8.5		ns		
Turn-On Rise Time	tR		2.7		ns		
Turn-Off Delay Time	tD(OFF)		11.9	_	ns	$V_{GS} = 10V, R_{GEN} = 6\Omega$	
Turn-Off Fall Time	tF		6.2	_	ns	<u> </u>	
Reverse Recovery Time	t _{RR}	_	33.2	_	ns	1 = -70 dl/dt = 1000/ug	
Reverse Recovery Charge	Qrr	_	34.3	_	nC	I _F = 7A, dl/dt = 100A/µs	

8. Short duration pulse test used to minimize self-heating effect.9. Guaranteed by design. Not subject to product testing. Notes:

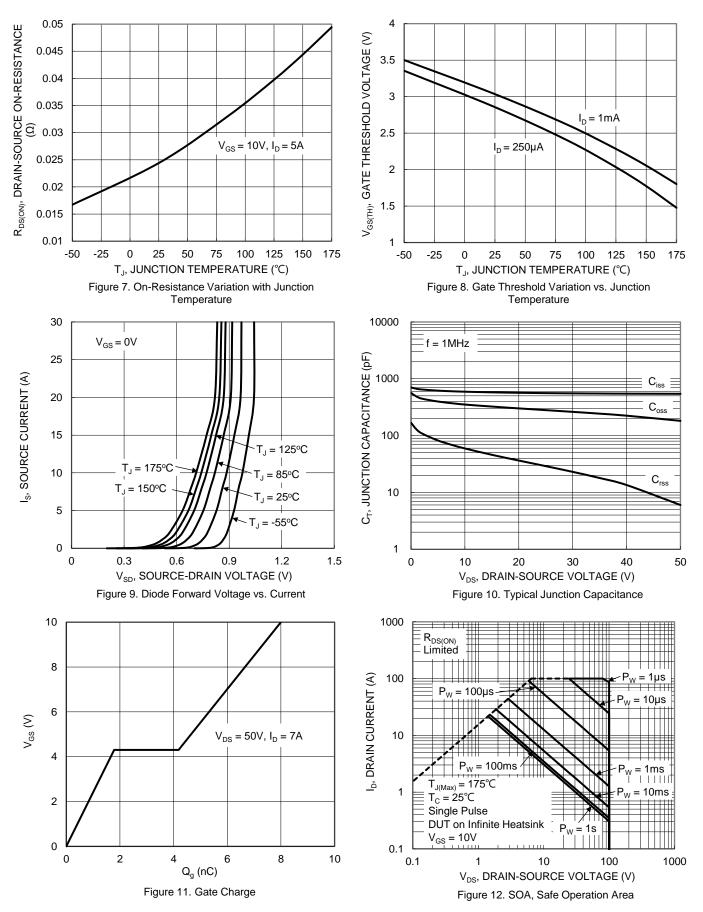


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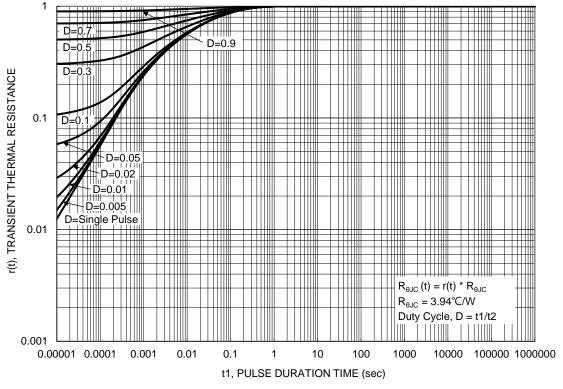
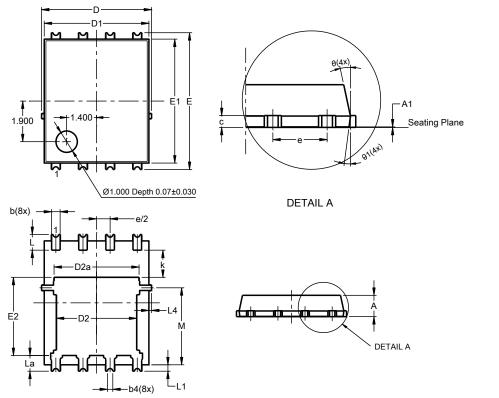


Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.



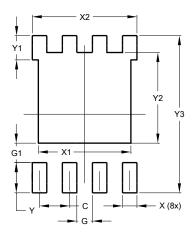
PowerDI5060-8 (SWP) (Type UX)

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Dim	Min	Тур		
Α	0.90	1.10	1.00	
A1	0	0.05		
b	0.30	0.50	0.41	
b2	0.20	0.35	0.25	
b4	().25REF	-	
С	0.230	0.330	0.277	
D	5	.15 BS0	0	
D1	4.70	5.10	4.90	
D2	3.56	3.96	3.76	
D2a	3.78	4.18	3.98	
ш	6	.40 BS0	2	
E1	5.60	6.00	5.80	
E2	3.46	3.86	3.66	
E2a	4.195	4.595	4.395	
e	1	.27BSC)	
k	1.05			
L	0.635	0.835	0.735	
La	0.635	0.835	0.735	
L1	0.200	0.400	0.300	
L1a	0.050REF			
L4	0.025	0.225	0.125	
М	3.205	4.005	3.605	
θ	10°	12°	11°	
θ1	6°	8°	7°	
All Dimensions in mm				

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8 (SWP) (Type UX)



Dimensions	Value (in mm)		
С	1.270		
G	0.660		
G1	0.820		
Х	0.610		
X1	4.100		
X2	4.420		
Y	1.270		
Y1	1.020		
Y2	3.810		
Y3	6.610		



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